



Electronics & Overmoulding Adhesive Solutions

Bio-Based
formulations
available

Complete solutions for the electronics industry's high demand for bond longevity & high heat resistance. **InnoV8®** from Intact provides reliability, easy processing and competitive gluing compared to other adhesive chemistries like polyamides or polyurethanes.

- High adhesion to difficult surfaces
- Easy to apply-open times to suit line speeds
- High heat resistance
- Low density formulations for increased process efficiency
- No harmful chemicals

Intact bonds to a wide variety of plastics with a high heat and chemical resistance.

We have solutions for low pressure overmoulding systems for the manufacture of sensors, flash drives and circuit boards and wire harness potting.

Free testing on your products in our lab - no need to stop your production line.

Keep production going®

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